2SC3793

Silicon NPN Epitaxial

HITACHI

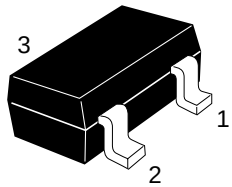
ADE-208-1091A (Z)
2nd. Edition
Mar. 2001

Application

UHF local oscillator

Outline

MPAK



1. Emitter
2. Base
3. Collector

Note: Marking is “IP-”.

Hitachi semiconductor

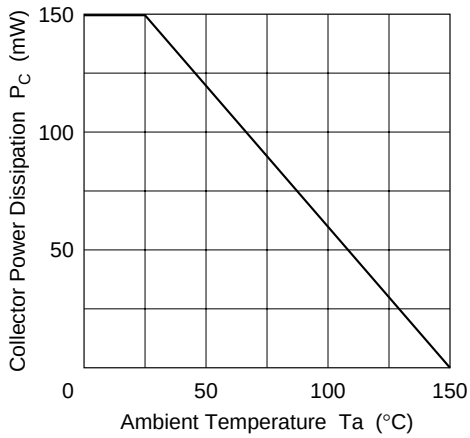
Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	20	V
Collector to emitter voltage	V_{CEO}	15	V
Emitter to base voltage	V_{EBO}	3	V
Collector current	I_C	50	mA
Collector power dissipation	P_C	150	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

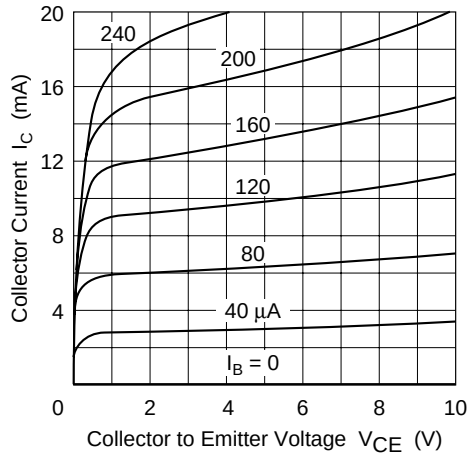
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	20	—	—	V	I_C = 10 µA, I_E = 0
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	15	—	—	V	I_C = 1 mA, R_{BE} = ∞
Collector cutoff current	I_{CBO}	—	—	1	µA	V_{CB} = 15 V, I_E = 0
Emitter cutoff current	I_{EBO}	—	—	1	µA	V_{EB} = 3 V, I_C = 0
DC current transfer ratio	h_{FE}	30	—	200		V_{CE} = 10 V, I_C = 5 mA
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	0.5	V	I_C = 20 mA, I_B = 4 mA
Collector output capacitance	Cob	—	0.7	1	pF	V_{CB} = 10 V, I_E = 0, f = 1MHz
Gain bandwidth product	f_T	—	2.9	—	GHz	V_{CE} = 10 V, I_C = 5 mA

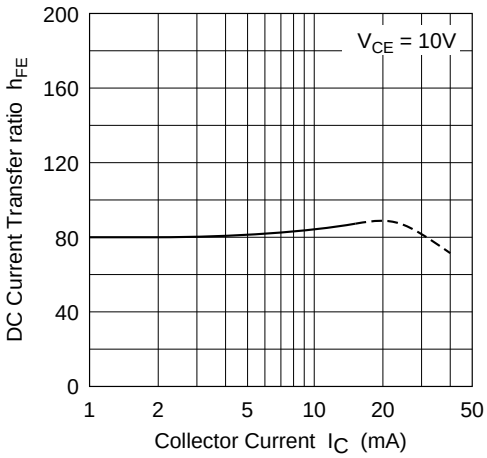
Maximum Collector Dissipation Curve



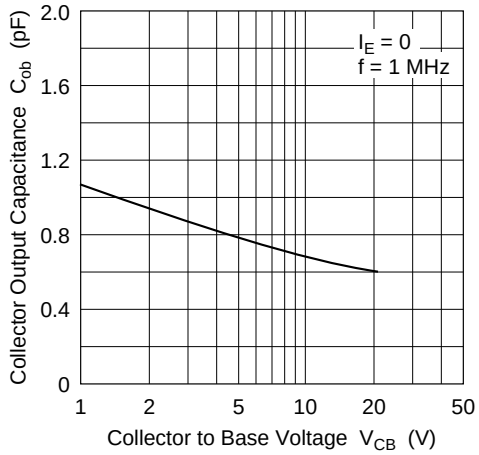
Typical Output Characteristics



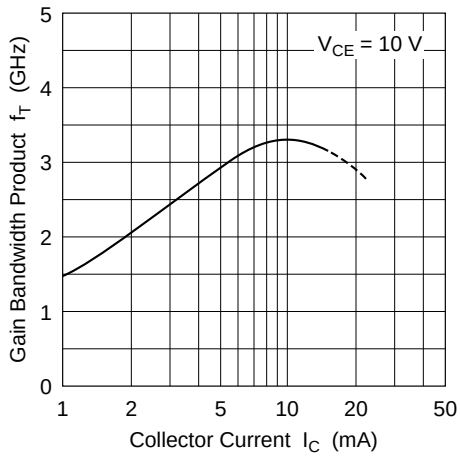
DC Current Transfer Ratio vs. Collector Current



Collector Output Cpacitance vs. Collector to Base Voltage

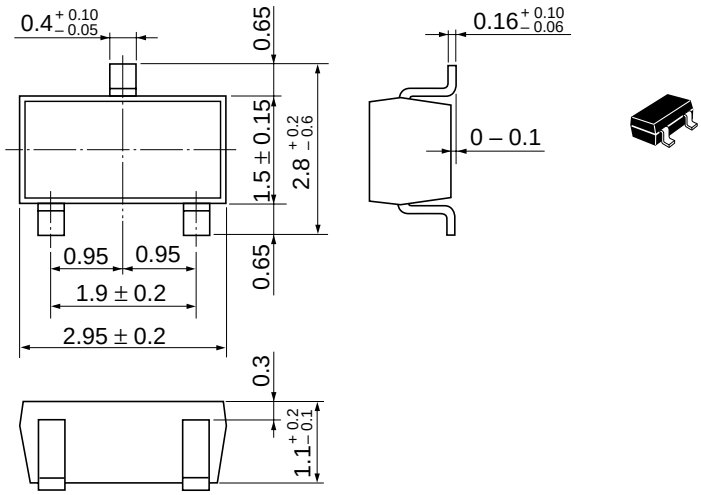


Gain Bandwidth Product
vs. Collector Current



Package Dimensions

As of January, 2001
Unit: mm



Hitachi Code	MPAK
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.011 g

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